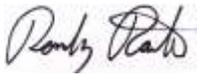


Ozone Depleting Substance Statement
Texas Instruments Semiconductor Products

Texas Instruments (TI) does not use Class I or Class II Ozone Depleting Substances (as defined by the US Clean Air Act and European Union Regulation (EC)1005/2009) as raw materials in the manufacture of semiconductor products. Some Class I and Class II ODS's are used in accordance with the law by TI in closed loop refrigeration cooling system heat exchangers to support manufacturing and Class II ODS's in cooling system heat exchangers.

TI carefully monitors these systems and is phasing out use of these substances as we upgrade facilities with new equipment and alternative refrigerants as they become available. TI supports the Montreal Protocol as the guidance document that outlines the controlled phase out of ODSs. TI does not purchase any reclaimed or recycled ODS material.

Sincerely,

A handwritten signature in black ink that reads "Randy Rath".

Randy Rath
TI SC Product Stewardship Management

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